

MDT101009	1280 x 800	LVDS Interface	TFT Module
Specification			
Version: 1		Date: 27/01/2019	
Revision			
1	25/01/2019	First issue	

Display Features			
Display Size	10.10"		
Resolution	1280 x 800		
Orientation	Landscape		
Appearance	RGB		
Logic Voltage	3.3V		
Interface	LVDS		
Brightness	450 cd/m ²		
Touchscreen	---		
Module Size	229.46 x 149.10 x 4.80 mm		
Operating Temperature	-20°C ~ +70°C	Created By	Checked By
Pinout	40 way FFC	WE	AB
Pitch	0.5 mm	Box Quantity	Weight / Display
		---	---

* - For full design functionality, please use this specification in conjunction with the HX8245 and HX8695 display driver specifications.(Provided Separately)

Display Accessories	
Part Number	Description
MBID-40FP	40 Way FFC to cable and wires. Driven by any driver board that can be wired to a 1mm pitch SHDR-40V-S-B receptacle.
MCIB14/16	HDMI-to-LVDS interface board, with voltage generation.
MDIB-CC1	Interconnect board for standard pitch pinouts to fine pitch wires. Providing pinouts for 2.54 pinout. 1.27, 1, 0.845, 0.8, 0.7, 0.65, 0.62, 0.6, 0.5 & 0.3 pads.

Optional Variants	
Appearances	Voltage



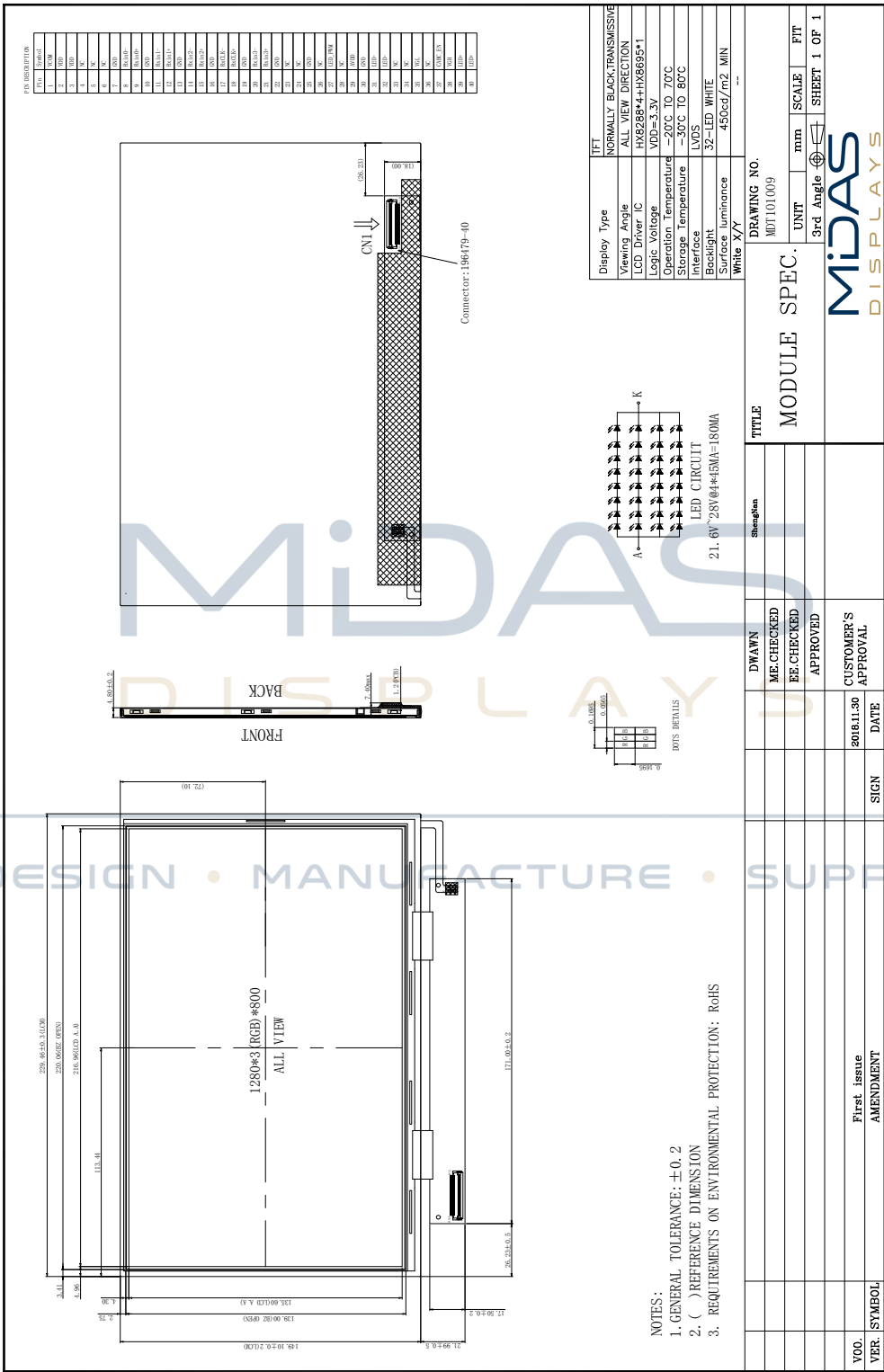
1. General Specification

Item	Contents	Unit
LCD TYPE	TFT/ TRANSMISSIVE	
MODULE SIZE (W*H*T)	229.46*149.1*4.8	MM
ACTIVE SIZE (W*H)	216.96*135.6	MM
PIXEL PITCH (W*H)	0.1695*0.1695	MM
NUMBER OF DOTS	1280*800	
DRIVER IC	HX8245+HX8695	
INTERFACE TYPE	LVDS	
TOP POLARIZER TYPE	-	
RECOMMEND VIEWING DIRECTION	ALL	O'CLOCK
GRAY SCALE INVERSION DIRECTION	--	O'CLOCK
BACKLIGHT TYPE	32-CHIP WHITE LED	
TOUCH PANEL TYPE	WITHOUT	

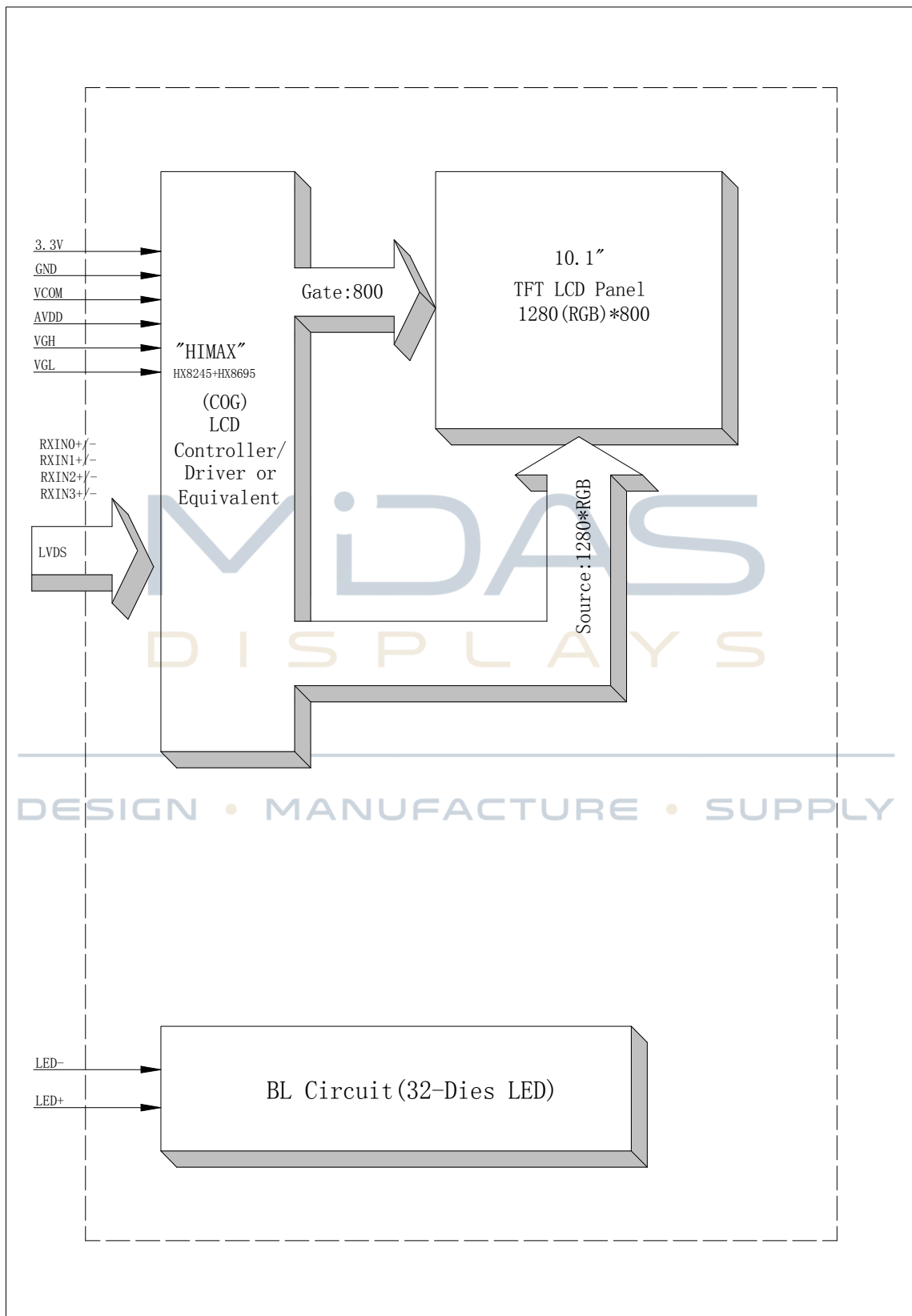
DESIGN • MANUFACTURE • SUPPLY



2. Mechanical Drawing



3. Block Diagram



4. Interface Pin Function

Pin No.	Symbol	Descriptin
1	VCOM	Common voltage
2	VDD	Logic power 3.3V
3	VDD	Logic power 3.3V
4	NC	No connect
5	NC	No connect
6	NC	No connect
7	GND	Power ground
8	RXIN0-	-LVDS differential data input
9	RXIN0+	+ LVDS differential data input
10	GND	Power ground
11	RXIN1-	-LVDS differential data input
12	RXIN1+	+ LVDS differential data input
13	GND	Power ground
14	RXIN2-	-LVDS differential data input
15	RXIN2+	+ LVDS differential data input
16	GND	Power ground
17	RXCLK-	-LVDS differential data input
18	RXCLK+	+ LVDS differential data input
19	GND	Power ground
20	RXIN3-	-LVDS differential data input
21	RXIN3+	+ LVDS differential data input
22	GND	Power ground
23	NC	No connect
24	NC	No connect
25	GND	Power supply
26	NC	No connect
27	LED_PWM	PWM SIGNAL TO TIMING CONTROLLER
28	NC	No connect
29	AVDD	Power supply
30	GND	Power ground
31	LED-	LED CATHODE
32	LED-	LED CATHODE
33	NC	No connect
34	NC	No connect
35	VGL	Gate OFF Voltage
36	NC	No connect
37	CABC_EN	CABC Enable Input



38	VGH	Gate ON Voltage
39	LED+	LED ANODE
40	LED+	LED ANODE

5. Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit
Supply voltage for analog	VDD	-0.3	3.9	V
Supply voltage for logic	VDD	-0.3	3.9	V
Supply current (One LED)	I _{LED}		60	mA
Operating temperature	T _{OP}	-20	+70	°C
Storage temperature	T _{ST}	-30	+80	°C

Note: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.



6. Electrical Characteristics

6.1 Input Power

Item	Symbol	Min.	Typ.	Max.	Unit	Applicable terminal
Supply Voltage for Analog	VDD	2.3	2.5	2.7	V	
Power voltage	AVDD	8.0	8.2	8.4	V	
Power voltage	VGH	21.7	22	22.3	V	
Power voltage	VGL	-7.3	-7	-6.7	V	
Input signal voltage	VCOM	2.7	3.0	3.3	V	
Input Voltage	V _{IL}	0	-	0.2VDD	V	
	V _{IH}	0.8 VDD	-	3.6		
Input leakage Current	I _{LKG}	-	-	-	μA	

6.2 Backlight Driving Conditions

Item	Symbol	Value			Unit	Remark
		Min.	Typ.	Max.		
Voltage for LED Backlight	V _F	22.4	25.6	27.2	V	I _L =180mA
Current for LED Backlight	I _L		180		mA	
Power Consumption	P		4.608		W	
LED Life Time		30,000	50,000		Hr	Note

Note: Brightness to be decreased to 50% of the initial value at ambient temperature TA=25℃

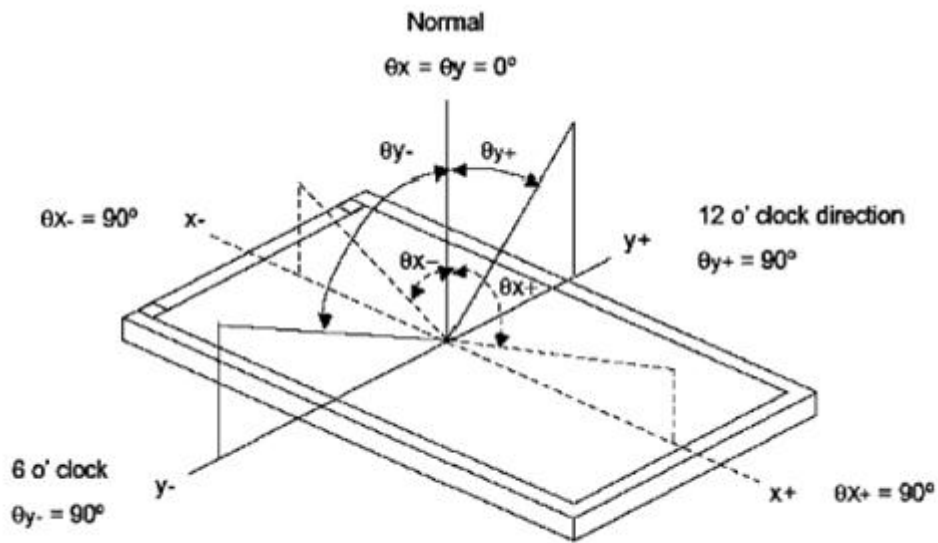


7. Optical Characteristics

ITEM		SYMBOL	CONDITIONS	SPECIFICATIONS			UNIT	NOTE
				MIN.	TYP.	MAX.		
Luminance		L	I_L =180mA	450	540		Cd/m ²	
Contrast Ratio		CR	$\theta=0^\circ$	600	800			
Response Time		T _{ON}	25℃		10	20	ms	
		T _{OFF}			15	30		
CIE Color Coordinate	Red	X _R	Viewing normal angle					
		Y _R						
	Green	X _G						
		Y _G						
	Blue	X _B						
		Y _B						
	White	X _W			TBD			
		Y _W			TBD			
Viewing Angle	Hor.	θ_{x+}	CR≥10	75	85		Degree	
		θ_{x-}		75	85			
	Ver.	θ_{y+}		75	85			
		θ_{y-}		75	85			
Uniformity	Un			70	75		%	



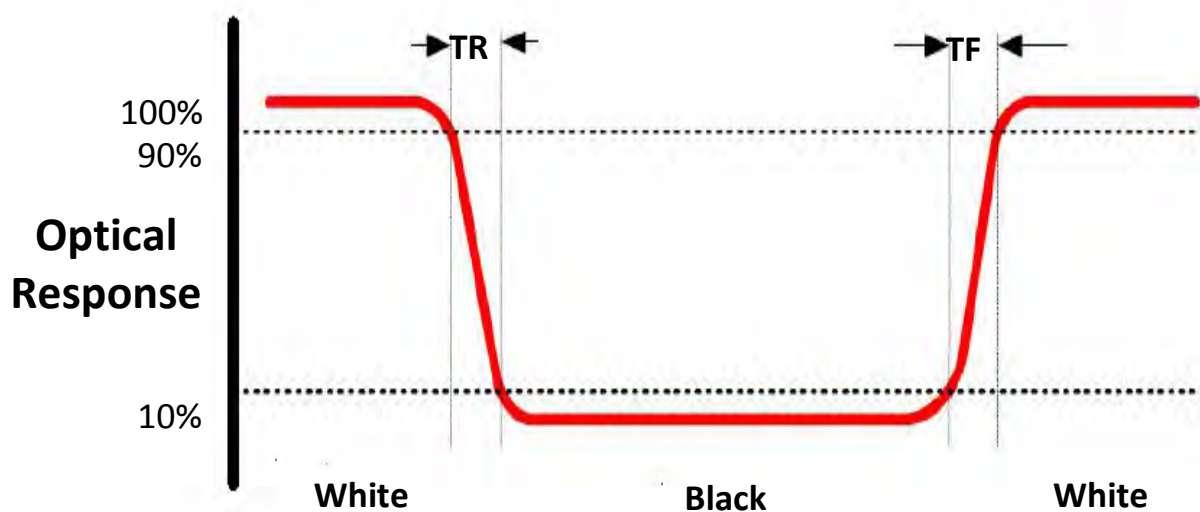
Note 1: Definition of Viewing Angle θ_x and θ_y :



Note 2: Definition of contrast ratio CR:

$$CR = \frac{\text{Luminance of white state}}{\text{Luminance of black state}}$$

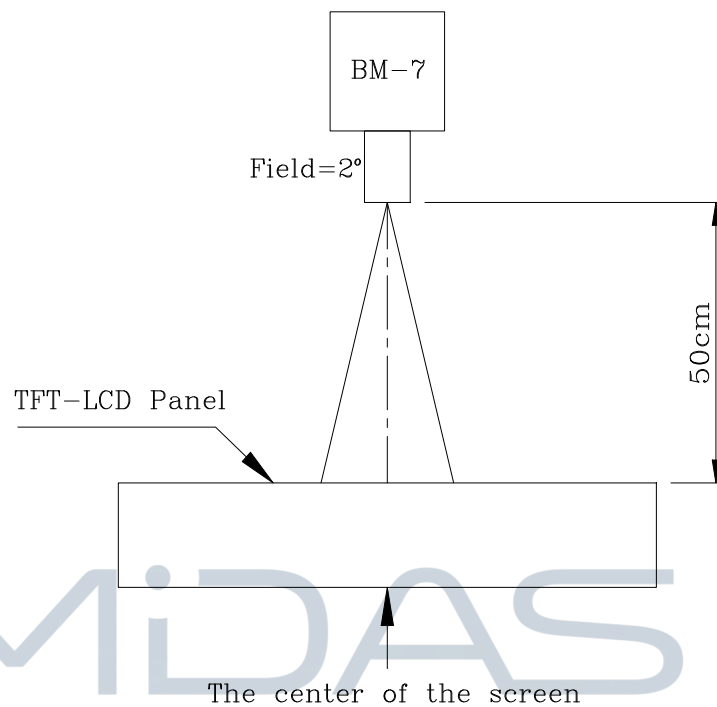
Note 3: Definition of Response Time (T_r, T_f)



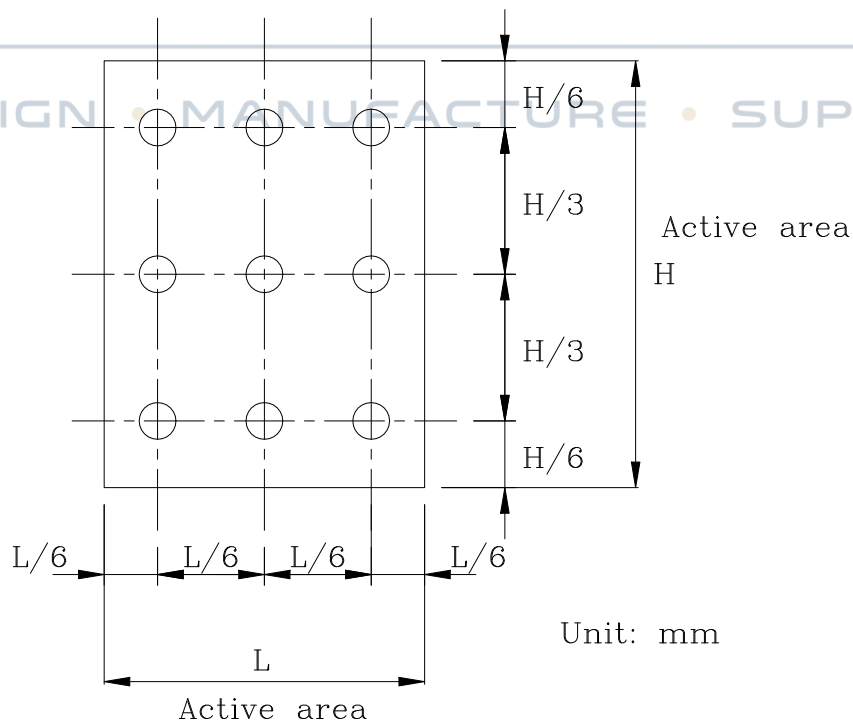
Note 4: Definition of Luminance

①The Brightness Test Equipment Setup

Field=2° (As measuring “black” image, field=2° is the best testing condition)



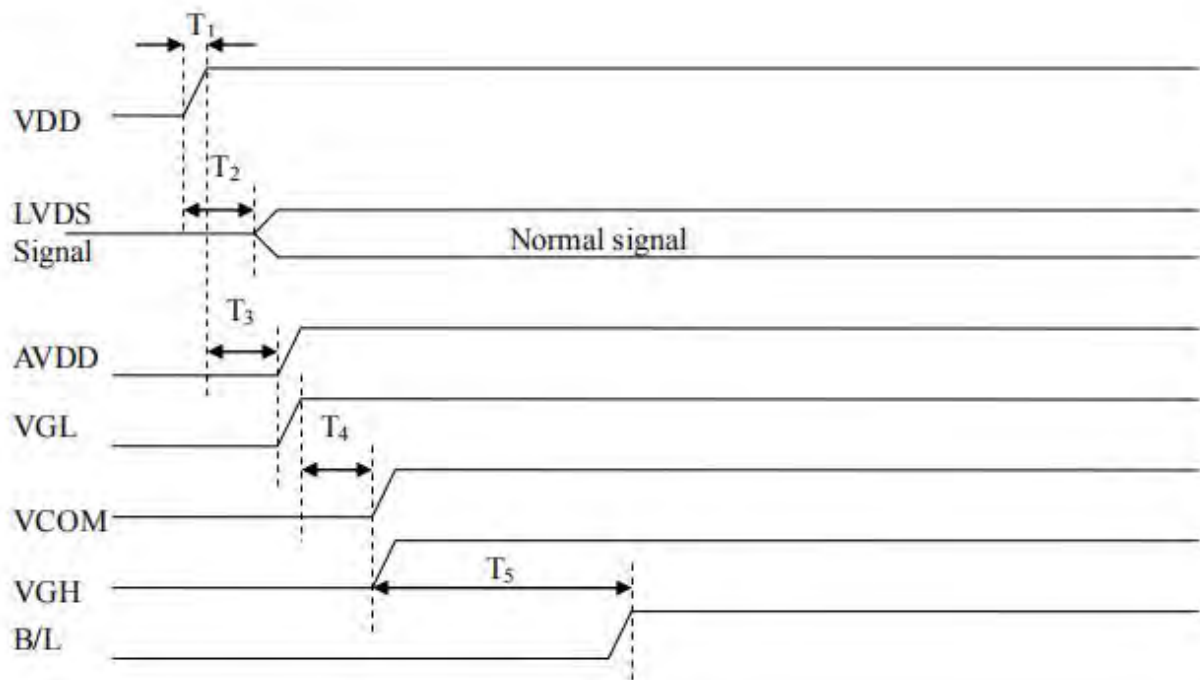
②The Brightness Test Point Setup



8. Timing Characteristics

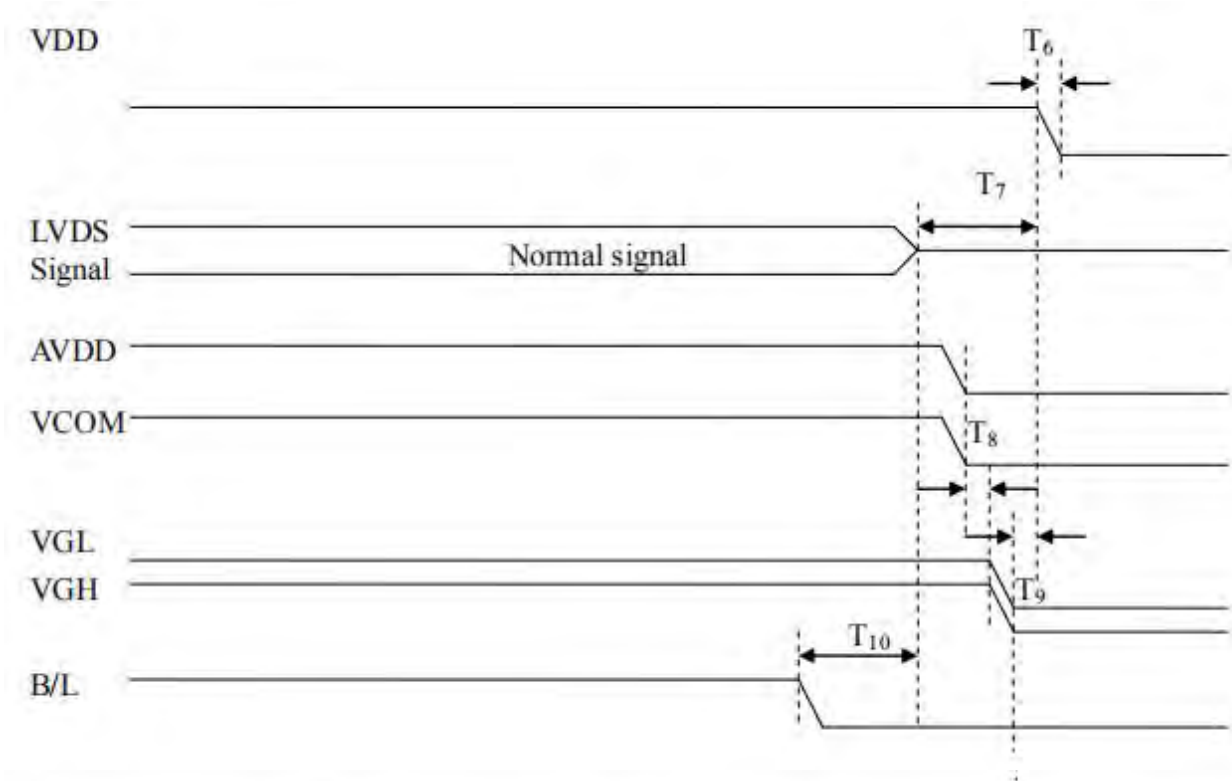
8.1 POWER SEQUENCE

a. Power on:



Symbol	Value			Unit
	Min.	Typ.	Max.	
T1	0.5	2	10	ms
T2	0	5	50	ms
T3	0	5	50	ms
T4	0	6	100	ms
T5	120	130	200	ms

POWER OFF

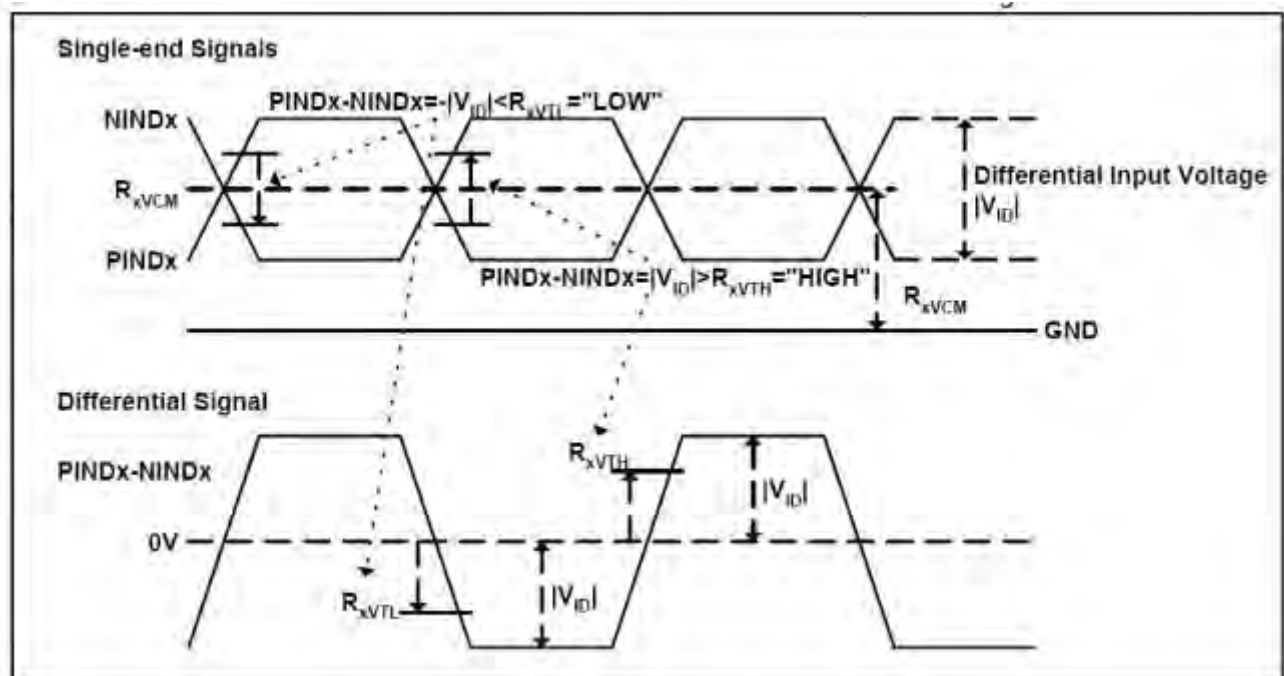


Symbol	Value			Unit
	Min.	Typ.	Max.	
T6	0.5	2	10	ms
T7	0	7	50	ms
T8	0	5	10	ms
T9	0	1	10	ms
T10	0	2	100	ms

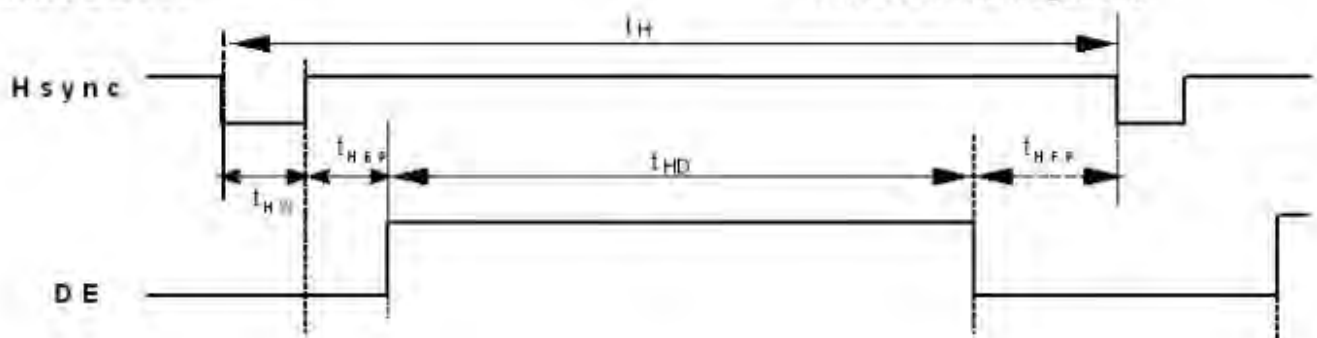
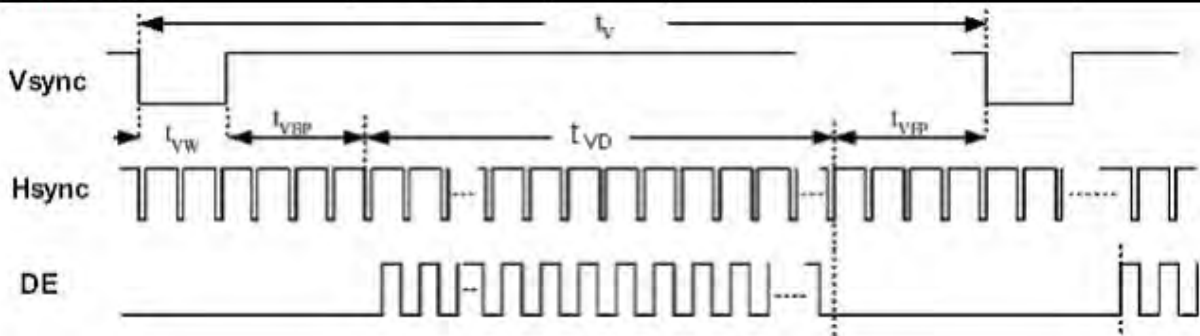


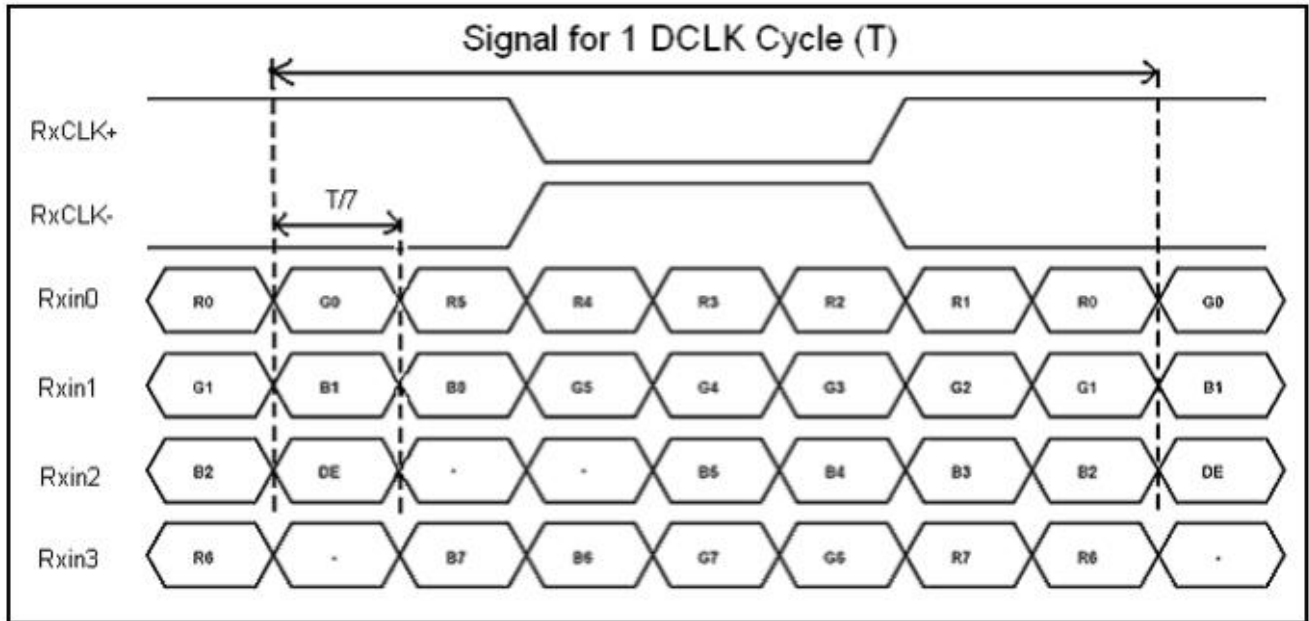
8.2 LVDS signal timing characteristic

Parameter	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
LVDS Differential input high Threshold voltage	R_{xVTH}	-	-	+100	mV	$R_{xVCM}=1.2V$
LVDS Differential input low Threshold voltage	R_{xVTL}	-100	-	-	mV	
LVDS Differential input common mode voltage	R_{xVCM}	0.7	-	1.6	V	
LVDS Differential voltage	$ V_{ID} $	200	-	600	mV	



Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Clock Frequency	1/Tc	(68.9)	71.1	(73.4)	MHz	Frame rate =60Hz
Horizontal display area	t _{HD}	1280			Tc	
HS period time	t _H	(1410)	1440	(1470)	Tc	
HS Width +Back Porch +Front Porch	t _{HW} + t _{HBP} +t _{HFP}	(60)	160	(190)	Tc	
Vertical display area	t _{VD}	800			t _H	
VS period time	t _V	(815)	823	(833)	t _H	
VS Width +Back Porch +Front Porch	t _{VW} + t _{VBP} +t _{VFP}	(15)	23	(33)	t _H	





MIDAS

DISPLAYS

DESIGN • MANUFACTURE • SUPPLY



9. Standard Specification for Reliability

9.1 Standard Specification for Reliability of LCD Module

No	Test Item	Condition	Remarks
1	High Temperature Operation	Ts = +70℃, 120 hours	IEC60068-21:2007 GB2423.2-2008
2	Low Temperature Operation	Ta = -20℃, 120 hours	IEC60068-2-1:2007 GB/2423.1-2008
3	High Temperature Storage	Ta = +80℃, 120 hours	IEC60068-21:2007 GB/2423.2-2008
4	Low Temperature Storage	Ta = -30℃, 120 hours	IEC60068-21:2007 GB/2423.1-2008
5	Operate at High Temperature and Humidity	Ta = +40℃, 90% RH max, 120 hours	IEC60068-2-78 :2001 GB/T2423.3—2006
6	Thermal Shock (non-operation)	-0℃/30 min~+50℃/30 for a total 100 Cycle	Start with cold temperature, End with high temperature, IEC60068-214:1984, GB/2423.22-2002
7	ESD	C=150pF, R=330Ω, 5point/panel Air:±8Kv, 5times; Contact:±4Kv, 5times (Environment: 15℃~35℃, 30%~60%.86Kpa~106Kpa)	IEC61000-42:2001 GB/T17626.2-2006
8	Vibration Test	Frequency range: 10~55Hz Stroke: 1.5mm Sweep: 10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z (6 hours for total)	IEC60068-2-6:1982 GB/T2423.10:1995
9	Mechanical Shock (Non Op)	Half Sine Wave 60G 6ms, ±X, ±Y, ±Z 3times for each direction	IEC60068-2-27:1987 GB/T2423.5—1995
10	Package Drop Test	Height: 80cm, 1corner, 3 edges, 6 surfaces	IEC60068-2-32:1990 GB/T2423.8—1995

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.

9.2 Testing Conditions and Inspection Criteria

For the final test, the testing sample must be stored at room temperature for 24 hours. After the tests listed in Table 9.2, standard specifications for reliability will be executed in order to ensure stability.

No.	Item	Test Model	Inspection Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

9.3 MTBF

MTBF	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($25\pm5^{\circ}\text{C}$), normal humidity ($50\pm10\%$ RH), and in area not exposed to direct sun light.
------	---

10. Specification of Quality Assurance

This standard of Quality Assurance confirms to the quality of LCD module products supplied by Midas.

10.1 Quality Test

Before delivering, the supplier should conduct the following tests to confirm the quality of products.

- Electrical-Optical Characteristics: According to the individual specification to test the product.
- Appearance Characteristics: According to the individual specification to test the product.
- Reliability Characteristics: According to the definition of reliability on the specification for testing products.

10.2 Delivery Test

Before delivering, the supplier should conduct the delivery test.

- Test method: According to MIL-STD105E. General Inspection Level II take a single Time.
- The defects classify of AQL as following:
 - Major defect: AQL = 0.65
 - Minor defect: AQL = 1.5
 - Total defects: AQL = 1.5

10.3 Non-conforming Analysis & Feedback

10.3.1 Non-conforming Analysis

- Purchaser should provide the data detail of non-conforming sample and the non-conforming.
- After receiving the data detail from purchaser, the analysis of non-conforming should be finished within two weeks.
- If the analysis can't be finished on time, supplier must notice purchaser 3 days in advance.



10.3.2 Disposition of non-conforming

- If any product defect be found during assembling, supplier must change the good for every defect after confirmation.
- Both supplier and customer should analyze the reason and discuss the disposition of non-conforming when the reason of nonconforming is not sure.

10.4 Agreement items

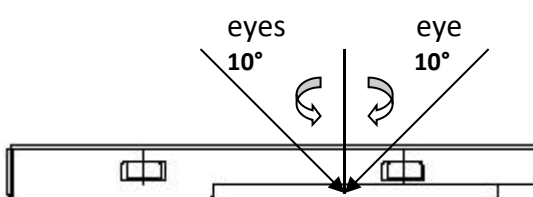
Both parties should negotiate together when the following problems happen.

- There is any problem of standard of quality assurance, and both sides should agree that it must be modified.
- There is any argument item which does not record in the standard of quality assurance.
- Any other special problem.

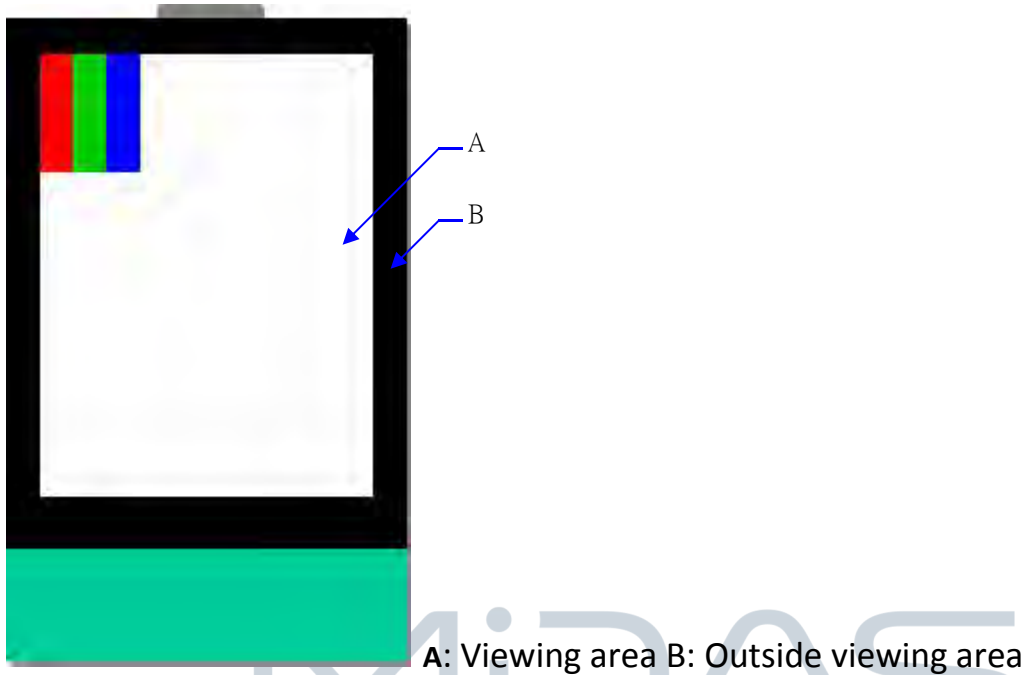
10.5 Standard of The Product Appearance Test

10.5.1 Manner of appearance test

- The test must be under 20W × 2 or 40W fluorescent light, and the distance of view must be at 30±5cm.
- When test the model of transmissive product must add the reflective plate.
- The test direction is base on around 10° of vertical line.
- Temperature: 25±5°C Humidity: 60±10%RH



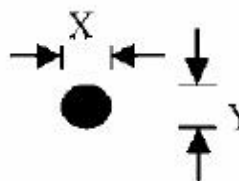
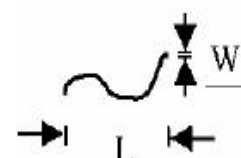
- Definition of area:

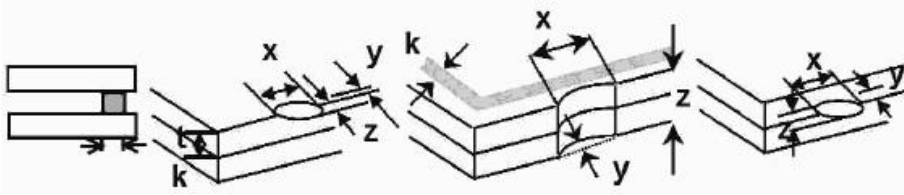
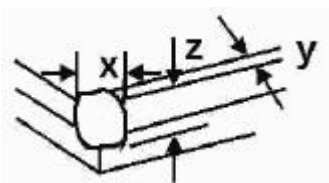


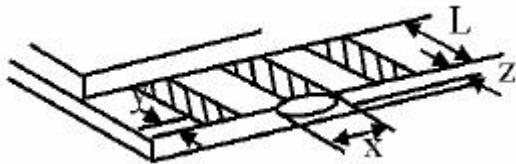
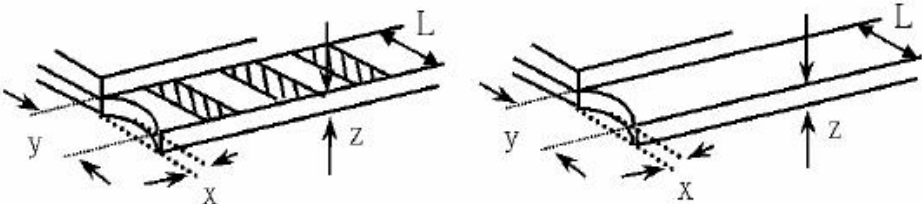
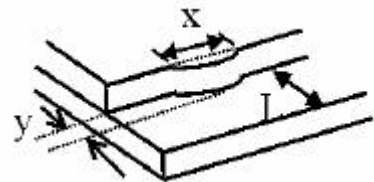
10.5.2 Basic principle

- When the standard can not be described, AQL will be applied.
- The sample of the lowest acceptable quality level must be negotiated by both supplier and customer when any dispute happened.
- New item must be added on time when it is necessary.

10.6 Inspection Specification

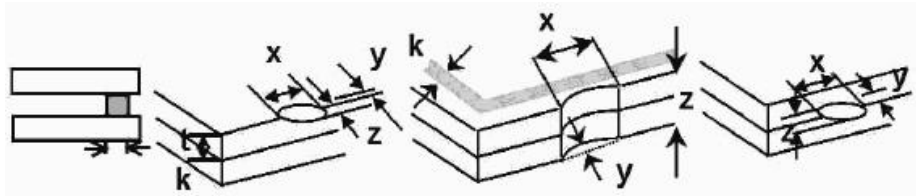
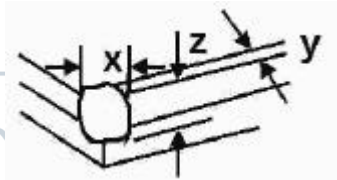
NO.	Item	Criterion	AQL														
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker	0.65														
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	2.1 White and black or color spots on display $\leq 0.25\text{mm}$, no more than Five spots. 2.2 Densely spaced: No more than three spots within 3mm.	1.5														
03	LCD and Touch Panel black spots, white spots, contamination (non – display)	3.1 Round type: As following drawing $\Phi = (X+Y) / 2$  <table><thead><tr><th>Size(mm)</th><th>Acceptable Q'ty</th></tr></thead><tbody><tr><td>$\Phi \leq 0.10$</td><td>Accept no dense</td></tr><tr><td>$0.10 < \Phi \leq 0.20$</td><td>2</td></tr><tr><td>$0.20 < \Phi \leq 0.25$</td><td>2</td></tr><tr><td>$0.25 < \Phi \leq 0.30$</td><td>1</td></tr><tr><td>$0.30 < \Phi$</td><td>0</td></tr></tbody></table> * Densely spaced: No more than two spots within 3mm.	Size(mm)	Acceptable Q'ty	$\Phi \leq 0.10$	Accept no dense	$0.10 < \Phi \leq 0.20$	2	$0.20 < \Phi \leq 0.25$	2	$0.25 < \Phi \leq 0.30$	1	$0.30 < \Phi$	0	1.5		
		Size(mm)	Acceptable Q'ty														
$\Phi \leq 0.10$	Accept no dense																
$0.10 < \Phi \leq 0.20$	2																
$0.20 < \Phi \leq 0.25$	2																
$0.25 < \Phi \leq 0.30$	1																
$0.30 < \Phi$	0																
		3.2 Line type: (As following drawing)  <table><thead><tr><th>Length(mm)</th><th>Width(mm)</th><th>Acceptable Q'ty</th></tr></thead><tbody><tr><td>---</td><td>$W \leq 0.02$</td><td>Accept no dense</td></tr><tr><td>$L \leq 3.0$</td><td>$0.02 < W \leq 0.05$</td><td rowspan="2">2</td></tr><tr><td>$L \leq 2.5$</td><td>$0.03 < W \leq 0.08$</td></tr><tr><td>---</td><td>$0.08 < W$</td><td>Rejection</td></tr></tbody></table> * Densely spaced: No more than two lines within 3mm.	Length(mm)	Width(mm)	Acceptable Q'ty	---	$W \leq 0.02$	Accept no dense	$L \leq 3.0$	$0.02 < W \leq 0.05$	2	$L \leq 2.5$	$0.03 < W \leq 0.08$	---	$0.08 < W$	Rejection	1.5
Length(mm)	Width(mm)	Acceptable Q'ty															
---	$W \leq 0.02$	Accept no dense															
$L \leq 3.0$	$0.02 < W \leq 0.05$	2															
$L \leq 2.5$	$0.03 < W \leq 0.08$																
---	$0.08 < W$	Rejection															

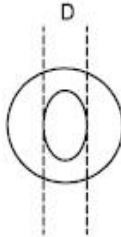
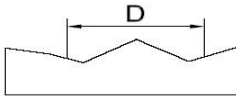
NO.	Item	Criterion			AQL
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction	Size Φ (mm)	Acceptable Q'ty	1.5
			$\Phi \leq 0.30$	Accept no dense	
			$0.30 < \Phi \leq 0.50$	0	
			$0.50 < \Phi \leq 1.00$	0	
			$1.00 < \Phi$	0	
			Total Q'ty	0	
05	Scratches	Follow NO.3 -2 Line Type.			
06	Chipped glass	Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:			1.5
					
		z: Chip thickness	y: Chip width	x: Chip length	
		$Z \leq 1/2t$	Not over viewing area	$x \leq 2MM$	
		$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 2MM$	
		⊙ Unit: mm ⊙ If there are 2 or more chips, x is the total length of each chip 6.1.2 Corner crack:			
					
		z: Chip thickness	y: Chip width	x: Chip length	
		$Z \leq 1/2t$	Not over viewing area	$x \leq 2MM$	
		$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 2MM$	
		⊙ Unit: mm ⊙ If there are 2 or more chips, x is the total length of each chip			

NO.	Item	Criterion	AQL																
07	Glass crack	Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad:  <table><tr><td>y: Chip width</td><td>x: Chip length</td><td>z: Chip thickness</td></tr><tr><td>$y \leq 0.5\text{mm}$</td><td>$x \leq 2\text{MM}$</td><td>$0 < z \leq t$</td></tr></table> 7.2.2 Non-conductive portion:  <table><tr><td>y: Chip width</td><td>x: Chip length</td><td>z: Chip thickness</td></tr><tr><td>$y \leq L$</td><td>$x \leq 2\text{MM}$</td><td>$0 < z \leq t$</td></tr></table> ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. ⊙ If the product will be heat sealed by the customer, the alignment mark must not be damaged. 7.2.3 Substrate protuberance and internal crack  <table><tr><td>y: width</td><td>x: length</td></tr><tr><td>$y \leq 1/3L$</td><td>$x \leq 2\text{MM}$</td></tr></table>	y: Chip width	x: Chip length	z: Chip thickness	$y \leq 0.5\text{mm}$	$x \leq 2\text{MM}$	$0 < z \leq t$	y: Chip width	x: Chip length	z: Chip thickness	$y \leq L$	$x \leq 2\text{MM}$	$0 < z \leq t$	y: width	x: length	$y \leq 1/3L$	$x \leq 2\text{MM}$	1.5
y: Chip width	x: Chip length	z: Chip thickness																	
$y \leq 0.5\text{mm}$	$x \leq 2\text{MM}$	$0 < z \leq t$																	
y: Chip width	x: Chip length	z: Chip thickness																	
$y \leq L$	$x \leq 2\text{MM}$	$0 < z \leq t$																	
y: width	x: length																		
$y \leq 1/3L$	$x \leq 2\text{MM}$																		

NO.	Item	Criterion	AQL
08	Cracked glass	No crack is allowed.	1.5
09	Backlight elements	9.1 Illumination source flickers when lit. 9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards. 9.3 Backlight doesn't illuminate or color is wrong.	1.5 1.5 0.65
10	Bezel	No scratches with $W > 0.1$ and $\text{Length} > 2.5\text{mm}$.	1.5
11	PCB、COB	11.1 COB seal may not have pinholes larger than 0.2mm or contamination. 11.2 COB seal surface may not have pinholes through to the IC. 11.3 The height of the COB should not exceed the height indicated in the assembly diagram. 11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places. 11.5 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 11.6 The jumper on the PCB should conform to the product characteristic chart.	1.5 1.5 1.5 1.5 0.65 0.65
12	FPC	FPC damage per IPC guidelines.(IPC-A-610) Nicks or damage along the edges of the flexible printed circuitry and cutouts, providing the penetration does not exceed 50% of the distance from the edge to the nearest conductor to 2.5mm[0.1in], Whichever is less.	1.5
13	Soldering	13.1 No cold solder joints, missing solder connections, oxidation or icicle. 13.2 No short circuits in components on PCB or FPC. 13.3 Soldering per IPC guidelines.(IPC-A-610)	1.5 0.65



NO.	Item	Criterion	AQL												
14	Touch Panel Chipped glass	Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Touch Panel Total thickness a: LCD side length L: Electrode pad length 14.1 General glass chip: 14.1.1 Chip on panel surface and crack between panels:  <table><tr><td>z: Chip thickness</td><td>y: Chip width</td><td>x: Chip length</td></tr><tr><td>$z \leq t$</td><td>$\leq 1/2 k$ and not over viewing area</td><td>$x \leq 2\text{MM}$</td></tr></table> ⊙ Unit: mm ⊙ If there are 2 or more chips, x is the total length of each chip 14.1.2 Corner crack:  <table><tr><td>z: Chip thickness</td><td>y: Chip width</td><td>x: Chip length</td></tr><tr><td>$z \leq t$</td><td>$\leq 1/2 k$ and not over viewing area</td><td>$x \leq 2\text{MM}$</td></tr></table> ⊙ Unit: mm ⊙ If there are 2 or more chips, x is the total length of each chip	z: Chip thickness	y: Chip width	x: Chip length	$z \leq t$	$\leq 1/2 k$ and not over viewing area	$x \leq 2\text{MM}$	z: Chip thickness	y: Chip width	x: Chip length	$z \leq t$	$\leq 1/2 k$ and not over viewing area	$x \leq 2\text{MM}$	1.5
z: Chip thickness	y: Chip width	x: Chip length													
$z \leq t$	$\leq 1/2 k$ and not over viewing area	$x \leq 2\text{MM}$													
z: Chip thickness	y: Chip width	x: Chip length													
$z \leq t$	$\leq 1/2 k$ and not over viewing area	$x \leq 2\text{MM}$													

NO.	Item	Criterion	AQL										
15	Touch Panel(Fish eye、dent and bubble on film)	<table><tr><th>SIZE(mm)</th><th>Acceptable Q'ty</th></tr><tr><td>$\Phi \leq 0.2$</td><td>Accept no dense</td></tr><tr><td>$0.2 < D \leq 0.4$</td><td>5</td></tr><tr><td>$0.4 < D \leq 0.5$</td><td>2</td></tr><tr><td>$0.5 < D$</td><td>0</td></tr></table> 	SIZE(mm)	Acceptable Q'ty	$\Phi \leq 0.2$	Accept no dense	$0.2 < D \leq 0.4$	5	$0.4 < D \leq 0.5$	2	$0.5 < D$	0	1.5
SIZE(mm)	Acceptable Q'ty												
$\Phi \leq 0.2$	Accept no dense												
$0.2 < D \leq 0.4$	5												
$0.4 < D \leq 0.5$	2												
$0.5 < D$	0												
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion($\leq 2.5\%$) , it is acceptable.	1.5										
17	Touch Panel Linearity	Less than 1.5% is acceptable.	1.5										
18	LCD Ripple	Touch the touch panel , can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g	1.5										
19	General appearance	19.1 Pin type must match type in specification sheet. 19.2 LCD pin loose or missing pins. 19.3 Product packaging must the same as specified on packaging specification sheet. 19.4 Product dimension and structure must conform to product specification sheet.	0.65 0.65 0.65 0.65										

11. Handling Precaution

11.1 Handling of LCM

- Avoid external shock.
- Don't apply excessive force on the surface.
- Liquid in LCD is hazardous substance, do not lick or swallow. When the liquid makes contact with your hand, skin, cloth, etc., wash it thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.
- The operators should wear protections whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- The modules should be kept in antistatic bags or other containers resistant to static for storage.
- The module is coated with a film to protect the display surface, be careful when peeling off this protective film since static electricity may be generated.

11.2 Storage

- Store it in an ambient temperature of $25\pm 10^{\circ}\text{C}$, and in a relative humidity of $50\pm 10\%\text{RH}$. Don't expose to sunlight or fluorescent light.
- Store it in a clean environment, free from dust, active gas, and solvent.
- Store it in anti-static electricity container.
- Store it without any physical load.

11.3 Soldering

- Use only soldering irons with proper grounding and no leakage.
- Iron: no higher than $280\pm 10^{\circ}\text{C}$ and less than 3 sec during hand soldering.
- Rewiring: no more than 2 times.

